

ANTREX Electronics

Electronic Components Sourcing Information

Product Reference Information

Part Number:	ZXMN10A25GTA
Manufacturer:	Diodes Incorporated
Package:	Please confirm with sales
Availability:	Please confirm with sales

Product Page:

<https://antrexco.com/product/details/diodes-incorporated/zxmn10a25gta.html>

Request a Quote:

[Submit RFQ for this part](#)



Scan for product page

Contact Information

Email: info@antrexco.com

WhatsApp: +86-186-8066-5326

Website: <https://antrexco.com>

Quality & Trust

New & Original Components

Supplier verification and packaging condition review

CoC / RoHS / REACH documents available on request

Secure sourcing support for OEM / EMS projects

Note:

This PDF includes an ANTREX product reference cover page.

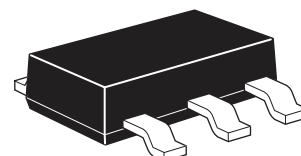
The original manufacturer datasheet follows from the next page.

ZXMN10A25G

100V SOT223 N-channel enhancement mode MOSFET

Summary

$V_{(BR)DSS}$	$R_{DS(on)} (\Omega)$	$I_D (A)$
100	0.125 @ $V_{GS} = 10V$	4
	0.150 @ $V_{GS} = 6V$	3.7

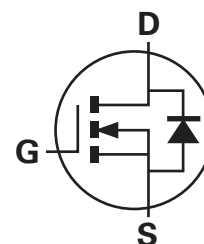


Description

This new generation trench MOSFET from Zetex features a unique structure which combines the benefits of low on-resistance and fast switching, making it ideal for high efficiency power management applications.

Features

- Low on-resistance
- Fast switching speed
- Low gate drive
- SOT223 package

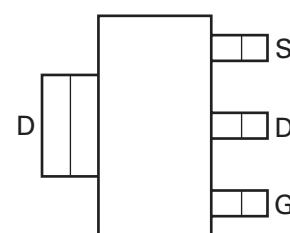


Applications

- DC-DC converters
- Power management functions
- Disconnect switches
- Motor control

Ordering information

Device	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXMN10A25GTA	7	12	1,000



Pinout - top view

Device marking

ZXMN
10A25

ZXMN10A25G

Absolute maximum ratings

Parameter	Symbol	Limit	Unit
Drain-source voltage	V_{DSS}	100	V
Gate-source voltage	V_{GS}	± 20	V
Continuous drain current @ $V_{GS} = 10V$; $T_{amb}=25^{\circ}C^{(b)}$ @ $V_{GS} = 10V$; $T_{amb}=70^{\circ}C^{(b)}$ @ $V_{GS} = 10V$; $T_{amb}=25^{\circ}C^{(a)}$	I_D	4 3.2 2.9	A
Pulsed drain current ^(c)	I_{DM}	17	A
Continuous source current (body diode) ^(b)	I_S	5.4	A
Pulsed source current (body diode) ^(c)	I_{SM}	17	A
Power dissipation at $T_{amb} = 25^{\circ}C^{(a)}$	P_D	2	W
Linear derating factor		16	mW/ $^{\circ}C$
Power dissipation at $T_{amb} = 25^{\circ}C^{(b)}$	P_D	3.9	W
Linear derating factor		31	mW/ $^{\circ}C$
Operating and storage temperature range	T_j, T_{stg}	-55 to +150	$^{\circ}C$

Thermal resistance

Parameter	Symbol	Limit	Unit
Junction to ambient ^(a)	$R_{\theta JA}$	62.5	$^{\circ}C/W$
Junction to ambient ^(b)	$R_{\theta JA}$	32	$^{\circ}C/W$

NOTES:

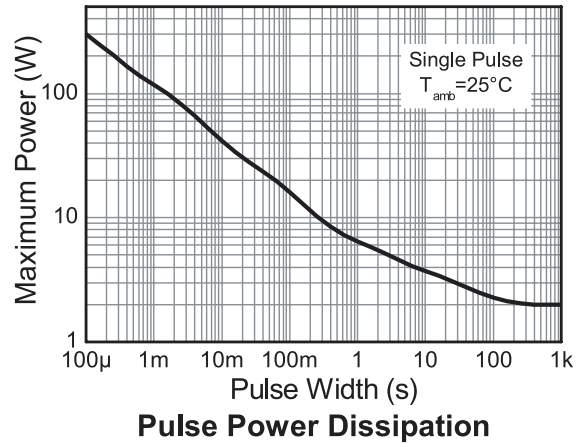
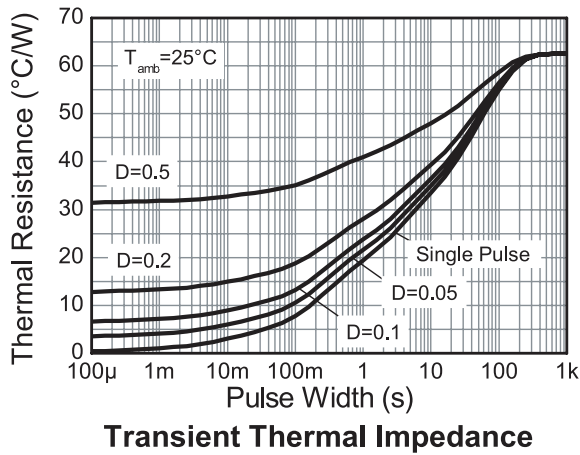
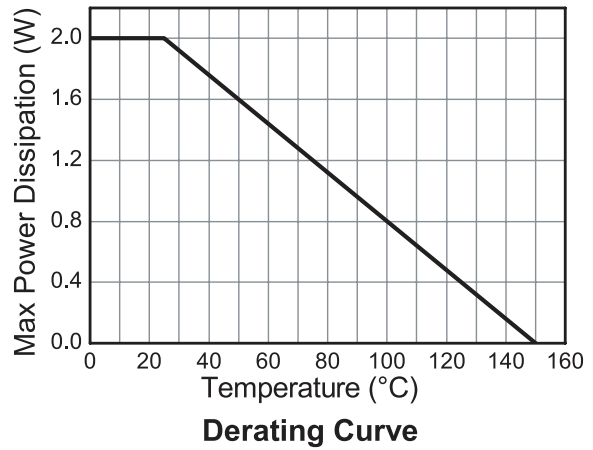
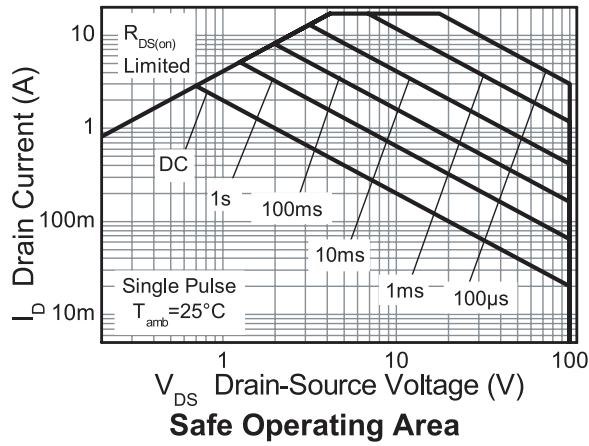
(a) For a device surface mounted on 25mm x 25mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions.

(b) For a device surface mounted on FR4 PCB measured at $t \leq 10$ sec.

(c) Repetitive rating - 25mm x 25mm FR4 PCB, $D=0.02$, pulse width $\leq 300\mu s$ - pulse width limited by maximum junction temperature.

ZXMN10A25G

Thermal characteristics



ZXMN10A25G

Electrical characteristics (at $T_{amb} = 25^{\circ}\text{C}$ unless otherwise stated)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Static						
Drain-source breakdown voltage	V _{(BR)DSS}	100			V	I _D = 250μA, V _{GS} =0V
Zero gate voltage drain current	I _{DSS}			0.5	μA	V _{DS} = 100V, V _{GS} =0V
Gate-body leakage	I _{GSS}			100	nA	V _{GS} =±20V, V _{DS} =0V
Gate-source threshold voltage	V _{GS(th)}	2.0		4.0	V	I _D = 250μA, V _{DS} =V _{GS}
Static drain-source on-state resistance ^(*)	R _{DS(on)}			0.125	Ω	V _{GS} = 10V, I _D = 2.9A
				0.150	Ω	V _{GS} = 6V, I _D = 2.6A
Forward transconductance ^{(*)(‡)}	g _{fs}		7.3		S	V _{DS} = 15V, I _D = 2.9A
Dynamic ^(‡)						
Input capacitance	C _{iss}		859		pF	V _{DS} = 50V, V _{GS} =0V f=1MHz
Output capacitance	C _{oss}		57		pF	
Reverse transfer capacitance	C _{rss}		33		pF	
Switching ^(†) (‡)						
Turn-on-delay time	t _{d(on)}		4.9		ns	V _{DD} = 50V, I _D = 1A R _G ≐6.0Ω, V _{GS} = 10V
Rise time	t _r		3.7		ns	
Turn-off delay time	t _{d(off)}		18		ns	
Fall time	t _f		9.4		ns	
Gate charge	Q _g		9.6		nC	V _{DS} = 50V, V _{GS} = 5V I _D = 2.9A
Total gate charge	Q _g		17		nC	V _{DS} = 50V, V _{GS} = 10V I _D = 2.9A
Gate-source charge	Q _{gs}		3.8		nC	
Gate drain charge	Q _{gd}		5.4		nC	
Source-drain diode						
Diode forward voltage ^(*)	V _{SD}		0.85	0.95	V	T _j =25°C, I _S = 4A, V _{GS} =0V
Reverse recovery time ^(‡)	t _{rr}		40.5		ns	T _j =25°C, I _S = 2.9A, di/dt=100A/μs
Reverse recovery charge ^(‡)	Q _{rr}		62		nC	

NOTES:

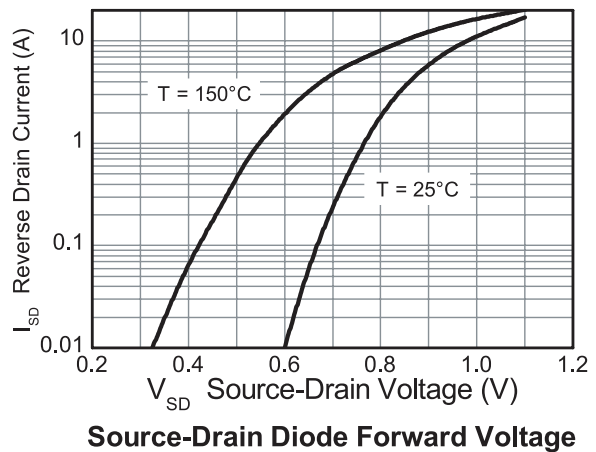
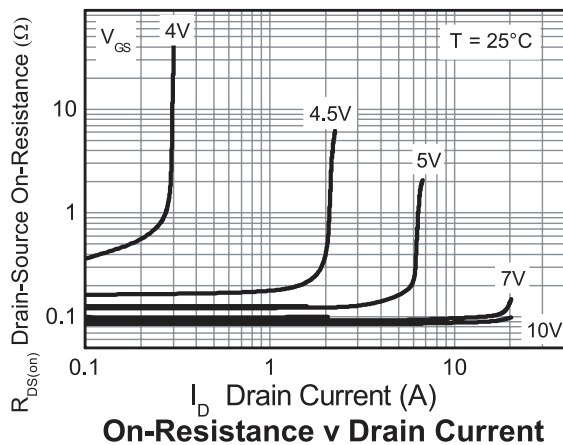
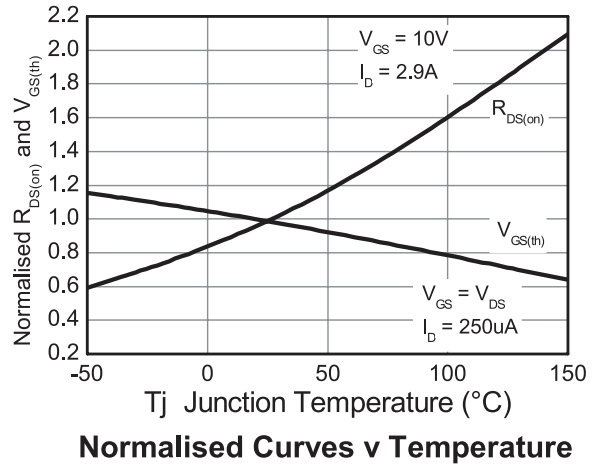
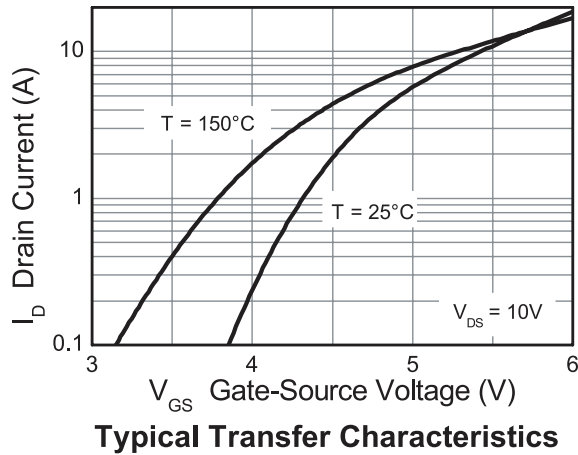
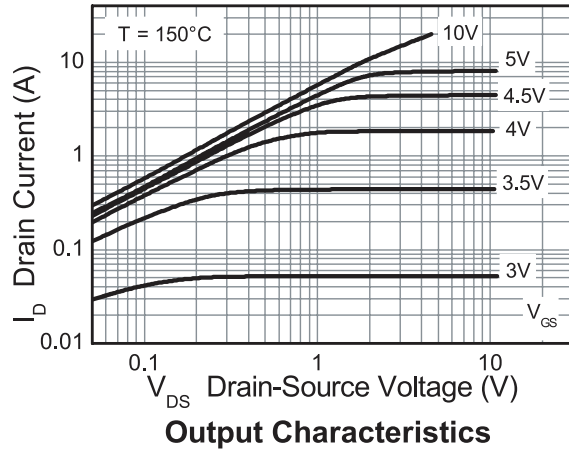
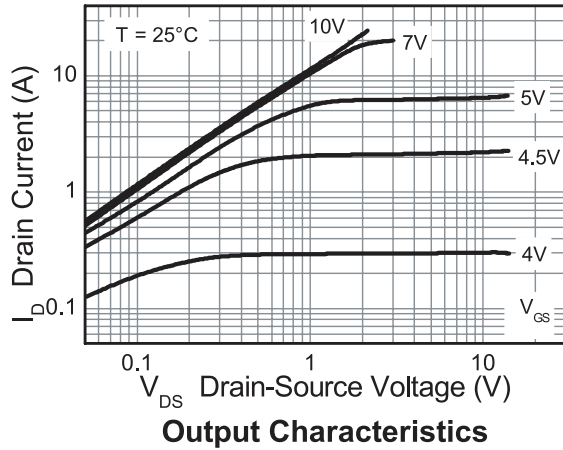
(*) Measured under pulsed conditions. Pulse width $\leq 300\mu\text{s}$; duty cycle $\leq 2\%$.

(†) Switching characteristics are independent of operating junction temperature.

(‡) For design aid only, not subject to production testing.

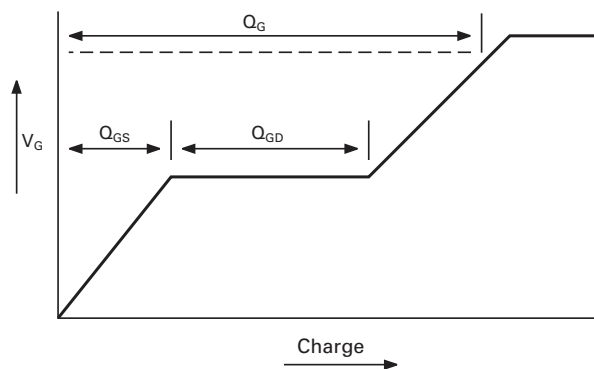
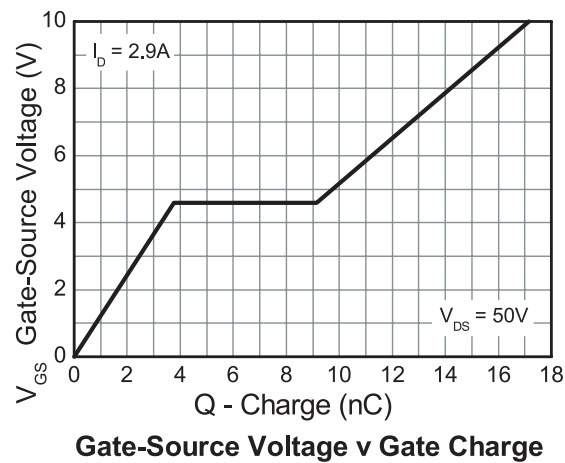
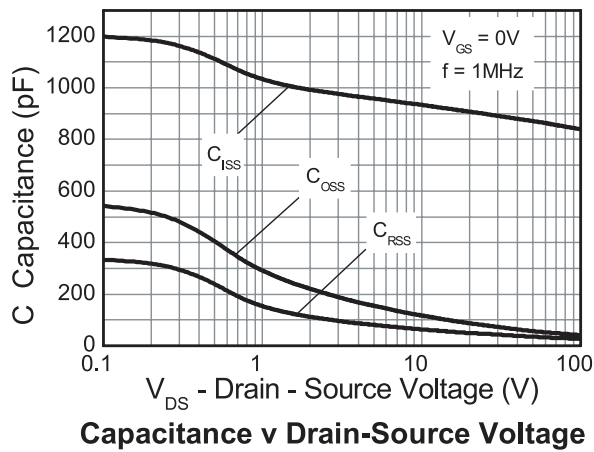
ZXMN10A25G

Typical Characteristics

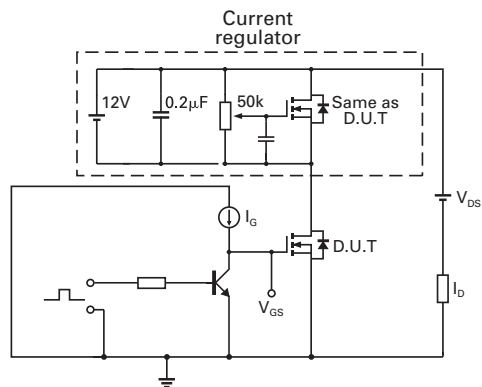


ZXMN10A25G

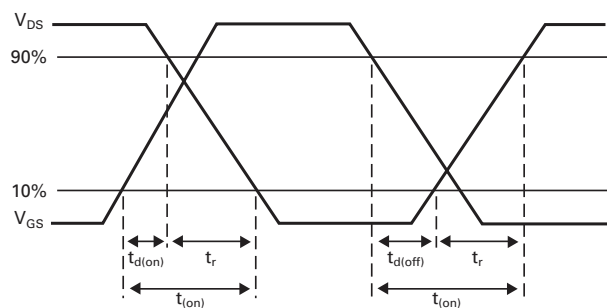
Typical Characteristics



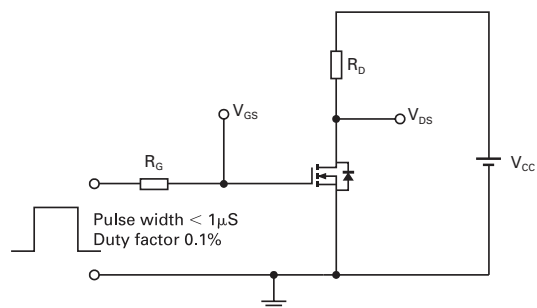
Basic gate charge waveform



Gate charge test circuit



Switching time waveforms



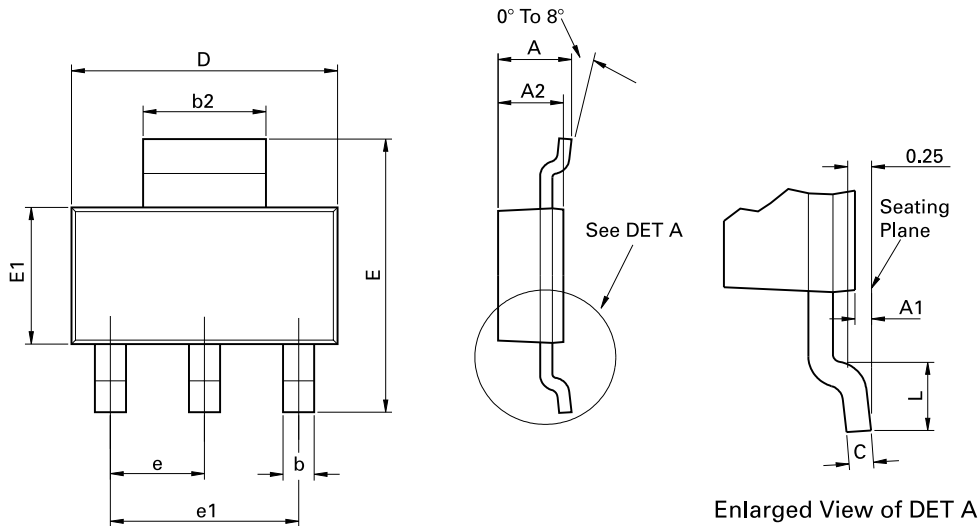
Switching time test circuit

ZXMN10A25G

Intentionally left blank

ZXMN10A25G

Package outline - SOT223



Conforms to JEDEC TO-261 AA Issue B

DIM	Millimeters		Inches		DIM	Millimeters		Inches	
	Min	Max	Min	Max		Min	Max	Min	Max
A	-	1.80	-	0.071	e	2.30 BSC		0.0905 BSC	
A1	0.02	0.10	0.0008	0.004	e1	4.60 BSC		0.181 BSC	
b	0.66	0.84	0.026	0.033	E	6.70	7.30	0.264	0.287
b2	2.90	3.10	0.114	0.122	E1	3.30	3.70	0.130	0.146
C	0.23	0.33	0.009	0.013	L	0.90	-	0.355	-
D	6.30	6.70	0.248	0.264	-	-	-	-	-

Note: Controlling dimensions are in millimeters. Approximate dimensions are provided in inches

Europe	Americas	Asia Pacific	Corporate Headquarters
Zetex GmbH Streitfeldstraße 19 D-81673 München Germany	Zetex Inc 700 Veterans Memorial Highway Hauppauge, NY 11788 USA	Zetex (Asia Ltd) 3701-04 Metroplaza Tower 1 Hing Fong Road, Kwai Fong Hong Kong	Zetex Semiconductors plc Zetex Technology Park, Chadderton Oldham, OL9 9LL United Kingdom
Telefon: (49) 89 45 49 49 0 Fax: (49) 89 45 49 49 49 europe.sales@zetex.com	Telephone: (1) 631 360 2222 Fax: (1) 631 360 8222 usa.sales@zetex.com	Telephone: (852) 26100 611 Fax: (852) 24250 494 asia.sales@zetex.com	Telephone: (44) 161 622 4444 Fax: (44) 161 622 4446 hq@zetex.com

For international sales offices visit www.zetex.com/offices

Zetex products are distributed worldwide. For details, see www.zetex.com/salesnetwork

This publication is issued to provide outline information only which (unless agreed by the company in writing) may not be used, applied or reproduced for any purpose or form part of any order or contact or be regarded as a representation relating to the products or services concerned. The company reserves the right to alter without notice the specification, design, price or conditions of supply of any product or service.